Docket	No	
DOCKCI	110.	

Westerman, Hattori, Daniels & Adrian, LLP

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

BIODEGRADABLE AND PRESSURE-SENSITIVE MATERIAL FOR MEDICAL USE

the specification	on of which is attached hereto un	less the following is che	cked		
was filed of PCT Internation	n <u>25.July.2005</u> as United States <i>A</i> onal Application Number <u>PCT/J</u>	Application Number	and was filed on 05 amended on(if a		
I hereby state t claim(s), as an	that I have reviewed and understance and understance and by any amendment referr	and the contents of the a ed above.	bove-identified specification,	, including the	
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pat	entability as defined in Title	37, Code of Federal	
for patent or in	foreign priority benefits under T iventor's certificate listed below ificate having a filing date before	and have also identified	below any foreign application	n for patent or	
(Tid min fraince				Priority Claimed	
(List prior foreign applications. See	2003-35710	Japan	13/February/2003	Yes □ No	
note A)	(Number)	(Country)	(Day/Month/Year Filed)		
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
				☐ Yes ☐ No	
(5 P)	(Number)	(Country)	(Day/Month/Year Filed)		
	See attached list for additional				
in the manner information wh	the benefit under Title 35, Unite subject matter of each of the claim provided by the first paragraph of nich is material to patentability a ecame available between the fili- plication.	ms of this application is of Title 35, United State s defined in Title 37, Co	not disclosed in the prior Unes Code, § 112, I acknowledgede of Federal Regulations	ited States application ge the duty to disclose	
(List prior U.S.			Status		
Applications)			☐ Patented ☐ Pend	ding Abandoned	
	(Application Serial No.)	(Filing Date)			
	(Application Serial No.)	(Filing Date)	Patented Peno	ding Abandoned	
			☐ Patented ☐ Pending ☐ Abandoned		
	(Application Serial No.)	(Filing Date)		<i>5</i> <u> </u>	
			☐ Patented ☐ Pend	ing Abandoned	
	(Application Serial No.)	(Filing Date)			

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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	Post Office Address					
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	Inventor's signature	(Date			
	Residence		Citizenship			
	Post Office Address					
						